

Bi-directional ESD Protection Diode

FEATURES

- Meet IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- Meet IEC61000-4-4 (EFT) rating. 40A (5/50ns)
- Protects one Bi-directional I/O line
- Working Voltage : 5V
- Pb free version and RoHS compliant
- Packing code with suffix "G" means green compound (halogen-free)

MECHANICAL DATA

- Case: SOD-523F small outline plastic package
- Terminal: Matte tin plated, lead free., solderable
- per MIL-STD-202, Method 208 guaranteed
- High temperature soldering guaranteed : 260°C/10s
- Weight: 2 ± 0.5 mg
- Marking code: TB

APPLICATIONS

- Cell Phone Handsets and Accessories
- Notebooks, Desktops, and Servers
- Personal Digital Assistants (PDA's)
- Portable Instrumentation
- Microprocessor Based Equipment

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MAXIMUM RATINGS AND ELECTRICAL CHAR	ACTERISTICS (T _A =25'	°C unless otherwis	e noted)	
PARAMETER	SYMBOL	VA	LUE	UNIT
Peak Pulse Power (tp=8/20µs waveform)	P _{PP}	100		W
ESD per IEC 61000-4-2 (Air)	V	±	15	
ESD per IEC 61000-4-2 (Contact)	V ESD	V _{ESD} ± 8		KV
	T _J , T _{STG}	-55 to +150		°C
Junction and Storage Temperature Range	IJ, ISTG	00 1		Ŭ
Junction and Storage Temperature Range	IJ, ISTG			0
PARAMETER	SYMBOL	MIN	MAX	

Reverse Stand-Off Voltage		V _{RWM}	-	5	V
Reverse Breakdown Voltage	I <mark>R</mark> ≓ 1 mA	V _(BR)	6	-	V
Reverse Leakage Current	V _R = 5 V	I _R	-	1	μA
Clamping Voltage	I _{PP} = 1 A	V	-	10	v
	I _{PP} = 5 A	V _c	-	15	
Junction Capacitance	V _R = 0 V , f = 1.0 MHz	C,		35	рF





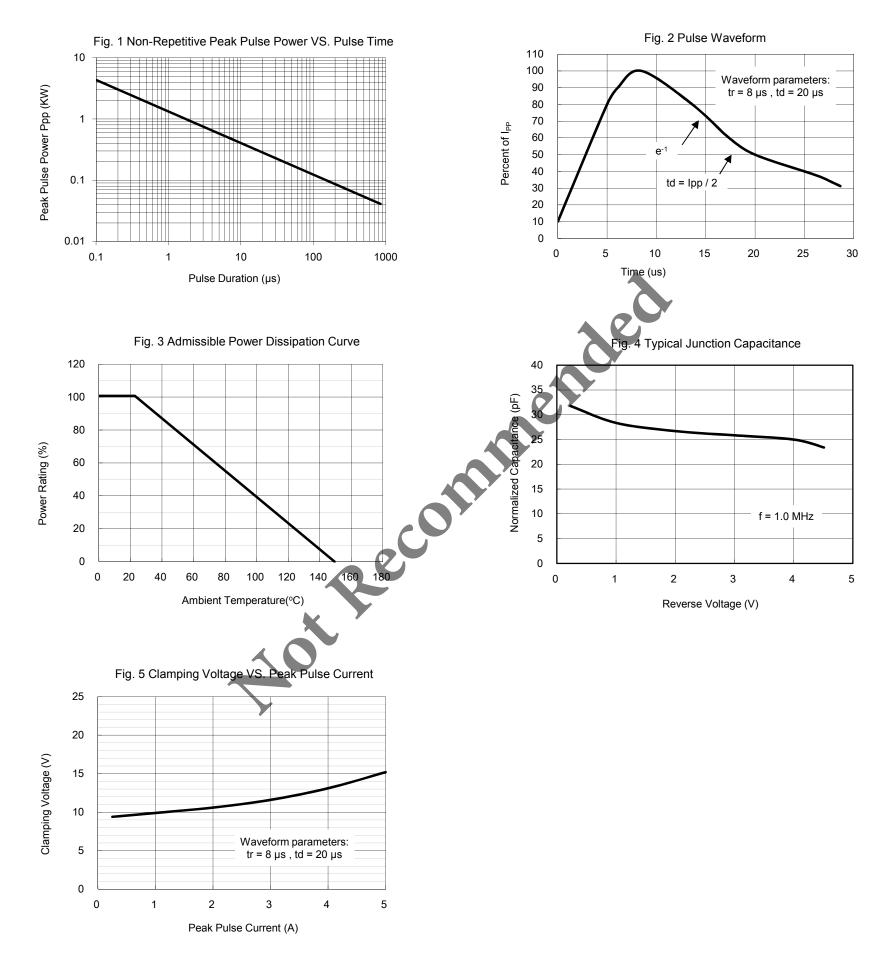
SOD-523F





RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)





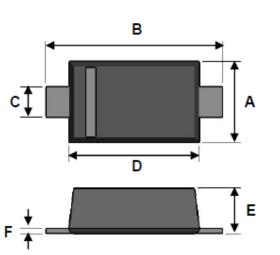
ORDER INFORMATION (EXAMPLE)

TESDD5V0HC RKG



Green compound code Packing code Part no.

PACKAGE OUTLINE DIMENSIONS SOD-523F



DIM.	Unit (mm)		Unit (inch)		
DIN.	Min	Max	Min	Max	
А	0.70	0.90	0.028	0.035	
В	1.50	1.70	0.059	0.067	
С	0.25	0.40	0.010	0.016	
D	1.10	1.30	0.043	0.051	
Е	0.50	0.77	0.020	0.030	
F	0.07	0.20	0.003	0.008	

SUGGEST PAD LAYOUT

F + E		leno	
→ A +	DIM.	Unit (mm)	Unit (inch)
		Тур.	Тур.
В	А	0.40	0.016
c b	В	0.40	0.016
	С	1.00	0.039
	D	1.80	0.071

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

APPLICATION INFROMATION

- Designed to protect one data, I/O, or power supply line
- Designed to protect sensitive electronics from damage or latch-up due to ESD
- Designed to replace multilayer varistors (MLVs) in portable applications
- Offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs
- The combination of small size and high ESD surge capability makes them ideal for use in portable applications

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

- Good circuit board layout is critical for the suppression of ESD induced transients
- Place the ESD Protection Diode near the input terminals or connectors to restrict transient coupling
- Minimize the path length between the ESD Protection Diode and the protected line
- Minimize all conductive loops including power and ground loops
- The ESD transient return path to ground should be kept as short as possible

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